## **ABSTRACT OF THE DISCLOSURE**

## **HEAT-DISSIPATING DEVICE**

A heat-dissipating device for a heat generating electronic component has a heat-conducting plate having a holding surface, a heat sink defining a clipping holed formed at a bottom thereof and a heat-conducting block received in the clipping hole and disposed on the holding surface so that the heat-dissipating device has a good heat-dissipating efficiency.

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